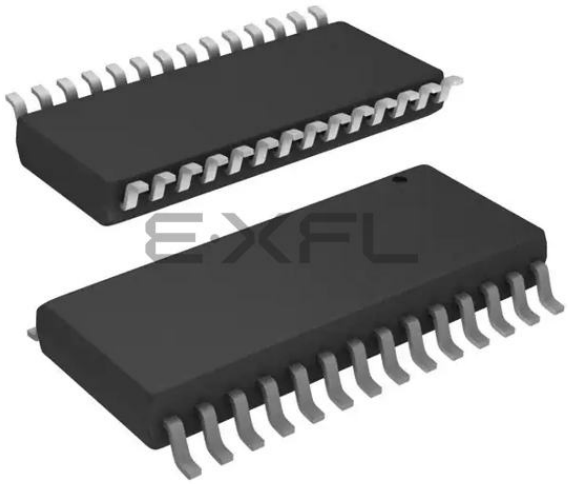

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Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LCD, POR, PWM, WDT
Number of I/O	24
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 20x12b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf19155-e-so

TABLE 1-3: PIC16(L)F19175/76 PINOUT DESCRIPTION (CONTINUED)

Name	Function	Input Type	Output Type	Description
RB3/C1IN2-/C2IN2-/IOCB3/ANB3/SEG11/SEGCFLY2	RB3	TTL/ST	CMOS/OD	General purpose I/O.
	C1IN2-	AN	—	Comparator negative input.
	C2IN2-	AN	—	Comparator negative input.
	IOCB3	TTL/ST	—	Interrupt-on-change input.
	ANB3	AN	—	ADC Channel input.
	SEG11	—	AN	LCD Analog output.
	SEGCFLY2	AN	—	LCD Drive Charge Pump Capacitor Inputs
RB4/ADCACT(1)/IOCB4/ANB4/COM0	RB4	TTL/ST	CMOS/OD	General purpose I/O.
	ADCACT(1)	TTL/ST	—	ADC Auto-Conversion Trigger input
	IOCB4	TTL/ST	—	Interrupt-on-change input.
	ANB4	AN	—	ADC Channel input.
	COM0	—	AN	LCD Driver Common Outputs.
RB5/T1G(1)/IOCB5/ANB5/SEG13/COM1	RB5	TTL/ST	CMOS/OD	General purpose I/O.
	T1G(1)	—	—	Timer1 Gate input.
	IOCB5	TTL/ST	—	Interrupt-on-change input.
	ANB5	AN	—	ADC Channel input.
	SEG13	-	AN	LCD Analog output.
	COM1	-	AN	LCD Driver Common Outputs.
RB6/CK2(3)/TX2(1)/CLCIN2(1)/IOCB6/ANB6/SEG14/ ICSPCLK	RB6	TTL/ST	CMOS/OD	General purpose I/O.
	CK2(3)	—	—	EUSART synchronous clock out
	TX2(1)	—	—	EUSART asynchronous TX data out
	CLCIN2(1)	—	—	Configurable Logic Cell source input.
	IOCB6	TTL/ST	—	Interrupt-on-change input.
	ANB6	AN	—	ADC Channel input.
	SEG14	—	AN	LCD Analog output.
	ICSPCLK	ST	—	In-Circuit Serial Programming™ and debugging clock input.
RB7/DK2(3)/RX2(1)/CLCIN3(1)/IOCB7/ANB7/SEG15/ DAC1OUT2/ICSPDAT	RB7	TTL/ST	CMOS/OD	General purpose I/O.
	DK2(3)	—	—	EUSART synchronous data output
	RX2(1)	—	—	EUSART receive input.
	CLCIN3(1)	—	—	Configurable Logic Cell source input.
	IOCB7	TTL/ST	—	Interrupt-on-change input.
	ANB7	—	AN	ADC Channel input.
	SEG15	—	AN	LCD Analog output.
	DAC1OUT2	—	AN	Digital-to-Analog Converter output.
	ICSPDAT	TTL/ST	TTL/ST	In-Circuit Serial Programming™ and debugging data input/output.

Legend: AN = Analog input or output CMOS = CMOS compatible input or output OD = Open-Drain
TTL = TTL compatible input' ST = Schmitt Trigger input with CMOS levels I^2C = Schmitt Trigger input with I^2C
HV = High Voltage XTAL = Crystal levels

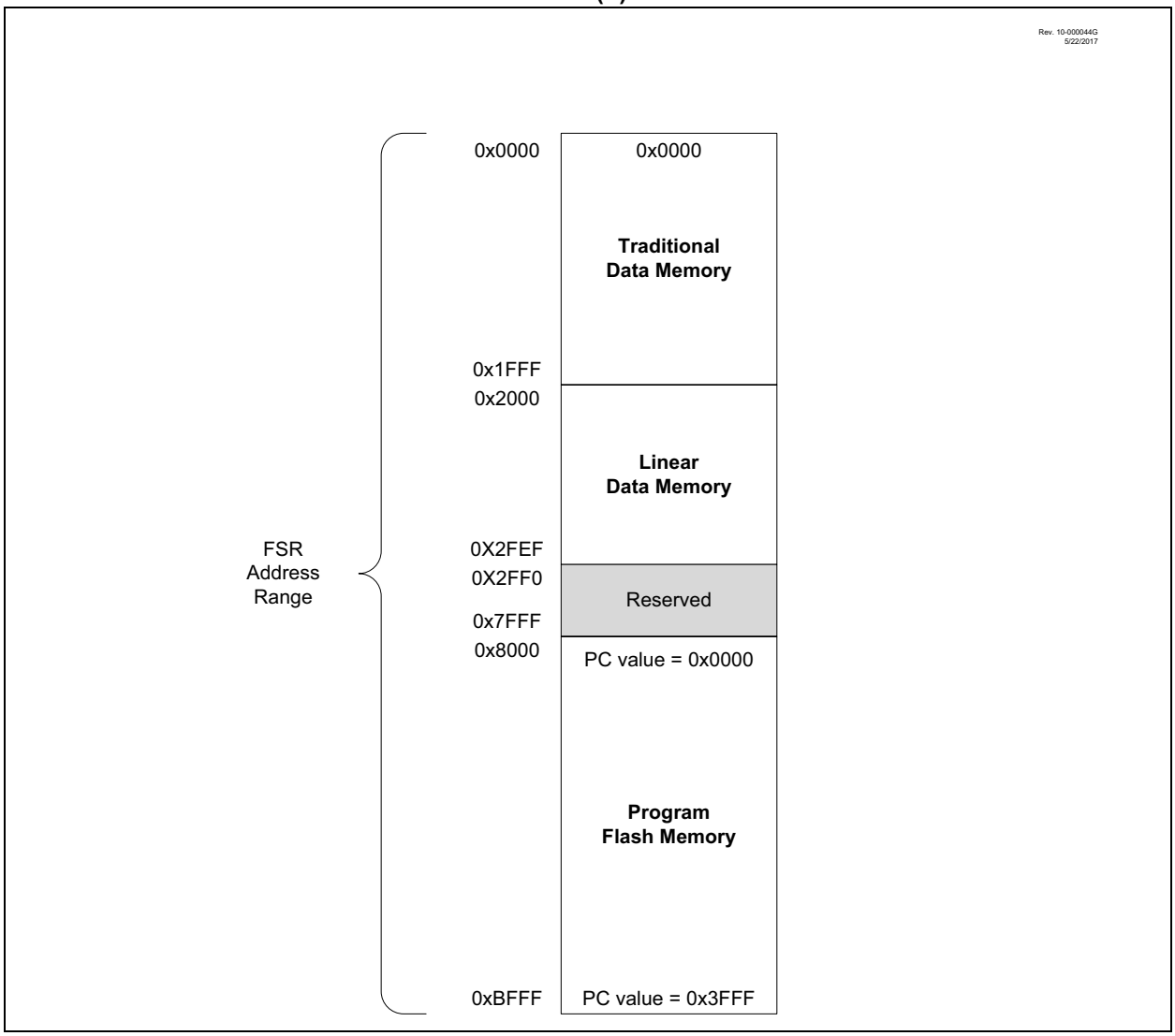
Note 1: This is a PPS remappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins. Refer to Table 14-2 for details on which PORT pins may be used for this signal.

2: All output signals shown in this row are PPS remappable. These signals may be mapped to output onto one of several PORTx pin options as described in Table 14-3.

3: This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.

4: These pins are configured for I^2C logic levels. The SCLx/SDAx signals may be assigned to any of the RB1/RB2/RC3/RC4 pins. PPS assignments to the other pins (e.g., RA5) will operate, but input logic levels will be standard TTL/ST, as selected by the INLVL register, instead of the I^2C specific or SMBus input buffer thresholds.

FIGURE 4-9: INDIRECT ADDRESSING PIC16(L)F19156/76/86



REGISTER 8-3: PCON1: POWER CONTROL REGISTER 1

U-0	U-0	U-0	U-0	U-0	U-0	R/W/HC-1/u	R/W/HC-q/u
—	—	—	—	—	—	$\overline{\text{MEMV}}$	$\overline{\text{VBATBOR}}$
bit 7							bit 0

Legend:		
HC = Bit is cleared by hardware		HS = Bit is set by hardware
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-m/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	q = Value depends on condition

bit 7-2 **Unimplemented:** Read as '0'.

bit 1 **MEMV:** Memory Violation Flag bit
1 = No Memory Violation Reset occurred or set to '1' by firmware
0 = A Memory Violation Reset occurred (set '0' in hardware when a Memory Violation occurs)

bit 0 **VBATBOR:** VBAT Brown-Out Reset Status Bit
1 = No VBAT Brown-out Reset occurred.
0 = A VBAT Brown-out Reset occurred.

8.17 VBAT System

The VBAT subsystem allows the RTCC and SOSC to run from a battery connected to the VBAT pin in the event of a VDD failure. Typically, the battery is a 3V coin cell, however the system is designed to operate over the entire VDD voltage range. If VDD is greater than VBAT, the RTCC and SOSC will be powered by VDD. If VDD is less than VBAT, the RTCC and SOSC will switch over to VBAT. See Table 4-5 and Table 4-8 for more information on the VBAT registers.

Note: It should be noted that in this second scenario, VDD may still be in the valid operating range, but anytime the VDD drops below VBAT, the RTCC and SOSC will switch over to VBAT. This means that in a system with a 3V battery and a 2.8V VDD, the RTCC and SOSC will run off VBAT even when VDD is present.

8.17.1 VBAT GPR SEMAPHORE REGISTERS

The VBAT voltage domain offers the user four registers: VB0GPR, VB1GPR, VB3GPR and VB4GPR. These registers can be used by firmware to write any information that needs to survive a VDD failure. As long as either VDD or VBAT is valid, these registers will hold the last value written.

REGISTER 14-13: WPUB: WEAK PULL-UP PORTB REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
WPUB7	WPUB6	WPUB5	WPUB4	WPUB3	WPUB2	WPUB1	WPUB0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **WPUB<7:0>**: Weak Pull-up Register bits(1)
1 = Pull-up enabled
0 = Pull-up disabled

Note 1: The weak pull-up device is automatically disabled if the pin is configured as an output.

REGISTER 14-14: ODCONB: PORTB OPEN-DRAIN CONTROL REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
ODCB7	ODCB6	ODCB5	ODCB4	ODCB3	ODCB2	ODCB1	ODCB0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **ODCB<7:0>:** PORTB Open-Drain Enable bits
For RB<7:0> pins, respectively
1 = Port pin operates as open-drain drive (sink current only)
0 = Port pin operates as standard push-pull drive (source and sink current)

14.7 Register Definitions: PORTC

REGISTER 14-18: PORTC: PORTC REGISTER

R/W-x/u	R/W-x/u	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
RC7	RC6	—	RC4	RC3	RC2	RC1	RC0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-6 **RC<7:6>**: PORTC General Purpose I/O Pin bits(1)
1 = Port pin is ≥ VIH
0 = Port pin is ≤ VIL

bit 5 **Unimplemented:** Read as '0'.

bit 4-0 **RC<4:0>**: PORTC General Purpose I/O Pin bits(1)
1 = Port pin is ≥ VIH
0 = Port pin is ≤ VIL

Note 1: Writes to PORTC are actually written to corresponding LATC register. Reads from PORTC register is return of actual I/O pin values.

REGISTER 14-19: TRISC: PORTC TRI-STATE REGISTER

R/W-1/1	R/W-1/1	U-0	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1
TRISC7	TRISC6	—	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-6 **TRISC<7:6>:** PORTC Tri-State Control bits
1 = PORTC pin configured as an input (tri-stated)
0 = PORTC pin configured as an output

bit 5 **Unimplemented:** Read as '0'.

bit 4-0 **TRISC<4:0>:** PORTC Tri-State Control bits
1 = PORTC pin configured as an input (tri-stated)
0 = PORTC pin configured as an output

TABLE 14-6: SUMMARY OF REGISTERS ASSOCIATED WITH PORTE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
PORTE	RE7	RE6	RE5	RE4	RE3	—	RE1	RE0	248
TRISE	TRISE7	TRISE6	TRISE5	TRISE4	TRISE3	—	TRISE1	TRISE0	248
LATE	LATE7	LATE6	LATE5	LATE4	LATE3	—	LATE1	LATE0	249
ANSELE	ANSE7	ANSE6	ANSE5	ANSE4	ANSE3	—	ANSE1	ANSE0	249
WPUE	WPUE7	WPUE6	WPUE5	WPUE4	WPUE3	—	WPUE1	WPUE0	250
ODCONE	ODCE7	ODCE6	ODCE5	ODCE4	ODCE3	—	ODCE1	ODCE0	250
SLRCONE	SLRE7	SLRE6	SLRE5	SLRE4	SLRE3	—	SLRE1	SLRE0	251
INLVLE	INLVLE7	INLVLE6	INLVLE5	INLVLE4	INLVLE3	—	INLVLE1	INLVLE0	251

Legend: x = unknown, u = unchanged, – = unimplemented locations read as '0'. Shaded cells are not used by PORTE.

TABLE 17-1: SUMMARY OF REGISTERS ASSOCIATED WITH INTERRUPT-ON-CHANGE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
INTCON	GIE	PEIE	—	—	—	—	—	INTEDG	164
PIE0	—	—	TMR0IE	IOCIE	—	—	—	INTE	165
IOCAP	IOCAP7	IOCAP6	IOCAP5	IOCAP4	IOCAP3	IOCAP2	IOCAP1	IOCAP0	277
IOCAN	IOCAN7	IOCAN6	IOCAN5	IOCAN4	IOCAN3	IOCAN2	IOCAN1	IOCAN0	277
IOCAF	IOCAF7	IOCAF6	IOCAF5	IOCAF4	IOCAF3	IOCAF2	IOCAF1	IOCAF0	277
IOCBP	IOCBP7	IOCBP6	IOCBP5	IOCBP4	IOCBP3	IOCBP2	IOCBP1	IOCBP0	278
IOCBN	IOCBN7	IOCBN6	IOCBN5	IOCBN4	IOCBN3	IOCBN2	IOCBN1	IOCBN0	278
IOCBF	IOCBF7	IOCBF6	IOCBF5	IOCBF4	IOCBF3	IOCBF2	IOCBF1	IOCBF0	278
IOCCP	IOCCP7	IOCCP6	—	IOCCP4	IOCCP3	IOCCP2	IOCCP1	IOCCP0	279
IOCCN	IOCCN7	IOCCN6	—	IOCCN4	IOCCN3	IOCCN2	IOCCN1	IOCCN0	279
IOCCF	IOCCF7	IOCCF6	—	IOCCF4	IOCCF3	IOCCF2	IOCCF1	IOCCF0	280
IOCEP	—	—	—	—	IOCEP3(1)	—	—	—	280
IOCEN	—	—	—	—	IOCEN3(1)	—	—	—	281
IOCEF	—	—	—	—	IOCEF3(1)	—	—	—	281

Note 1: — = unimplemented location, read as '0'. Shaded cells are not used by interrupt-on-change.

2: If MCLRE = 1 or LVP = 1, RE3 port functionality is disabled and IOC on RE3 is not available.

REGISTER 19-35: ADACT: ADC AUTO-CONVERSION TRIGGER CONTROL REGISTER

U-0	U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	—	ACT<4:0>				
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-5 **Unimplemented**: Read as '0'

bit 4-0 **ACT<4:0>**: Auto-Conversion Trigger Select Bits
11111 = Software write to ADPCH
11110 = Reserved, do not use
11101 = Software read of ADRESH
11100 = Software read of ADERRH
11011 = CLC4_out
11010 = CLC3_out
11001 = CLC2_out
11000 = CLC1_out
10111 = Logical OR of all Interrupt-on-change Interrupt Flags
10110 = CMP2_out
10101 = CMP1_out
10100 = Reserved, do not use
10011 = Reserved, do not use
10010 = Reserved, do not use
10001 = Reserved, do not use
10000 = Reserved, do not use
01111 = PWM4_out
01110 = PWM3_out
01101 = Reserved, do not use
01100 = Reserved, do not use
01011 = CCP2_trigger
01010 = CCP1_trigger
01001 = SMT1_trigger
01000 = RTCC Seconds
00111 = Reserved, do not use
00110 = TMR4_postscaled
00101 = Reserved, do not use
00100 = TMR2_postscaled
00011 = TMR1_overflow
00010 = TMR0_overflow
00001 = Pin selected by ADCACTPPS
00000 = External Trigger Disabled

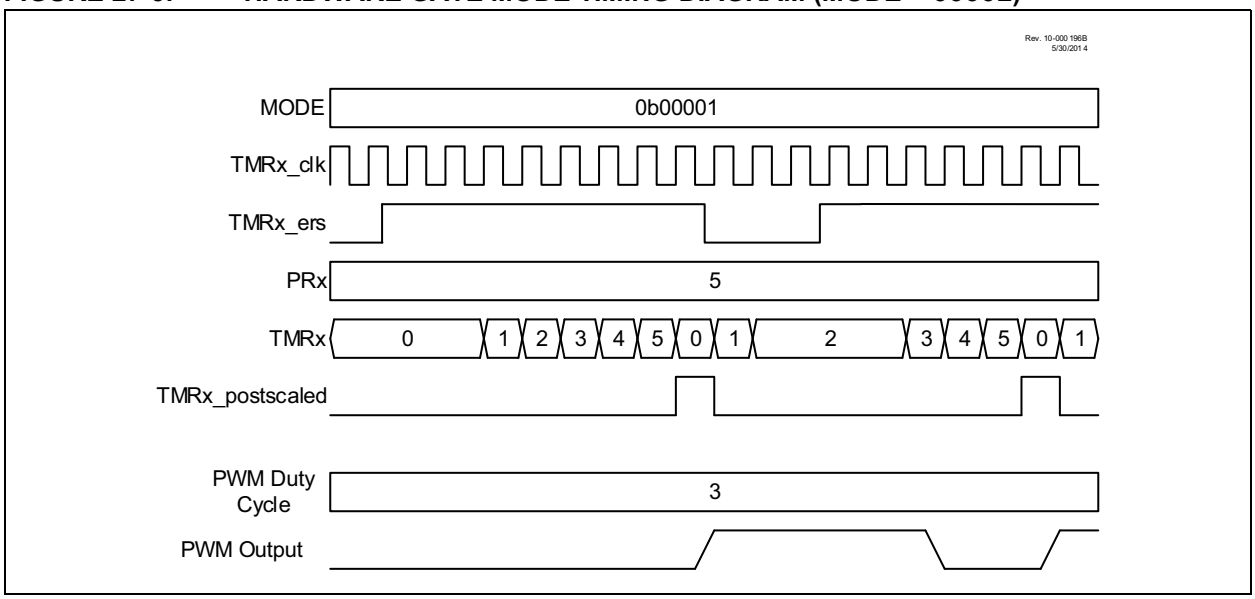
27.5.2 HARDWARE GATE MODE

The Hardware Gate modes operate the same as the Software Gate mode except the TMRx_ers external signal gates the timer. When used with the CCP the gating extends the PWM period. If the timer is stopped when the PWM output is high then the duty cycle is also extended.

When MODE<4:0> = 00001 then the timer is stopped when the external signal is high. When MODE<4:0> = 00010 then the timer is stopped when the external signal is low.

Figure 27-5 illustrates the Hardware Gating mode for MODE<4:0> = 00001 in which a high input level starts the counter.

FIGURE 27-5: HARDWARE GATE MODE TIMING DIAGRAM (MODE = 00001)



31.0 COMPLEMENTARY WAVEFORM GENERATOR (CWG) MODULE

The Complementary Waveform Generator (CWG) produces half-bridge, full-bridge, and steering of PWM waveforms. It is backwards compatible with previous ECCP functions.

The CWG has the following features:

- Six Operating modes:
  - Synchronous Steering mode
  - Asynchronous Steering mode
  - Full-Bridge mode, Forward
  - Full-Bridge mode, Reverse
  - Half-Bridge mode
  - Push-Pull mode
- Output Polarity Control
- Output Steering:
  - Synchronized to rising event
  - Immediate effect
- Independent 6-Bit Rising and Falling Event Dead-Band Timers:
  - Clocked dead band
  - Independent rising and falling dead-band enables
- Auto-Shutdown Control with:
  - Selectable shutdown sources
  - Auto-restart enable
  - Auto-shutdown pin override control

The CWG modules available are shown in Table 31-1.

TABLE 31-1: AVAILABLE CWG MODULES

Device	CWG1
PIC16(L)F19155/56/75/76/85/86	●

31.1 Fundamental Operation

The CWG module can operate in six different modes, as specified by MODE of the CWG1CON0 register:

- Half-Bridge mode (Figure 31-9)
- Push-Pull mode (Figure 31-2)
  - Full-Bridge mode, Forward (Figure 31-3)
  - Full-Bridge mode, Reverse (Figure 31-3)
- Steering mode (Figure 31-10)
- Synchronous Steering mode (Figure 31-11)

It may be necessary to guard against the possibility of circuit faults or a feedback event arriving too late or not at all. In this case, the active drive must be terminated before the Fault condition causes damage. Thus, all output modes support auto-shutdown, which is covered in **Section 31.10 “Auto-Shutdown”**.

31.1.1 HALF-BRIDGE MODE

In Half-Bridge mode, two output signals are generated as true and inverted versions of the input as illustrated in Figure 31-9. A non-overlap (dead-band) time is inserted between the two outputs as described in **Section 31.5 “Dead-Band Control”**.

The unused outputs CWG1C and CWG1D drive similar signals, with polarity independently controlled by the POLC and POLD bits of the CWG1CON1 register, respectively.

REGISTER 31-3: CWG1DBR: CWG1 RISING DEAD-BAND COUNTER REGISTER

U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
—	—	DBR<5:0>					
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	q = Value depends on condition

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-0 **DBR<5:0>:** Rising Event Dead-Band Value for Counter bits

REGISTER 31-4: CWG1DBF: CWG1 FALLING DEAD-BAND COUNTER REGISTER

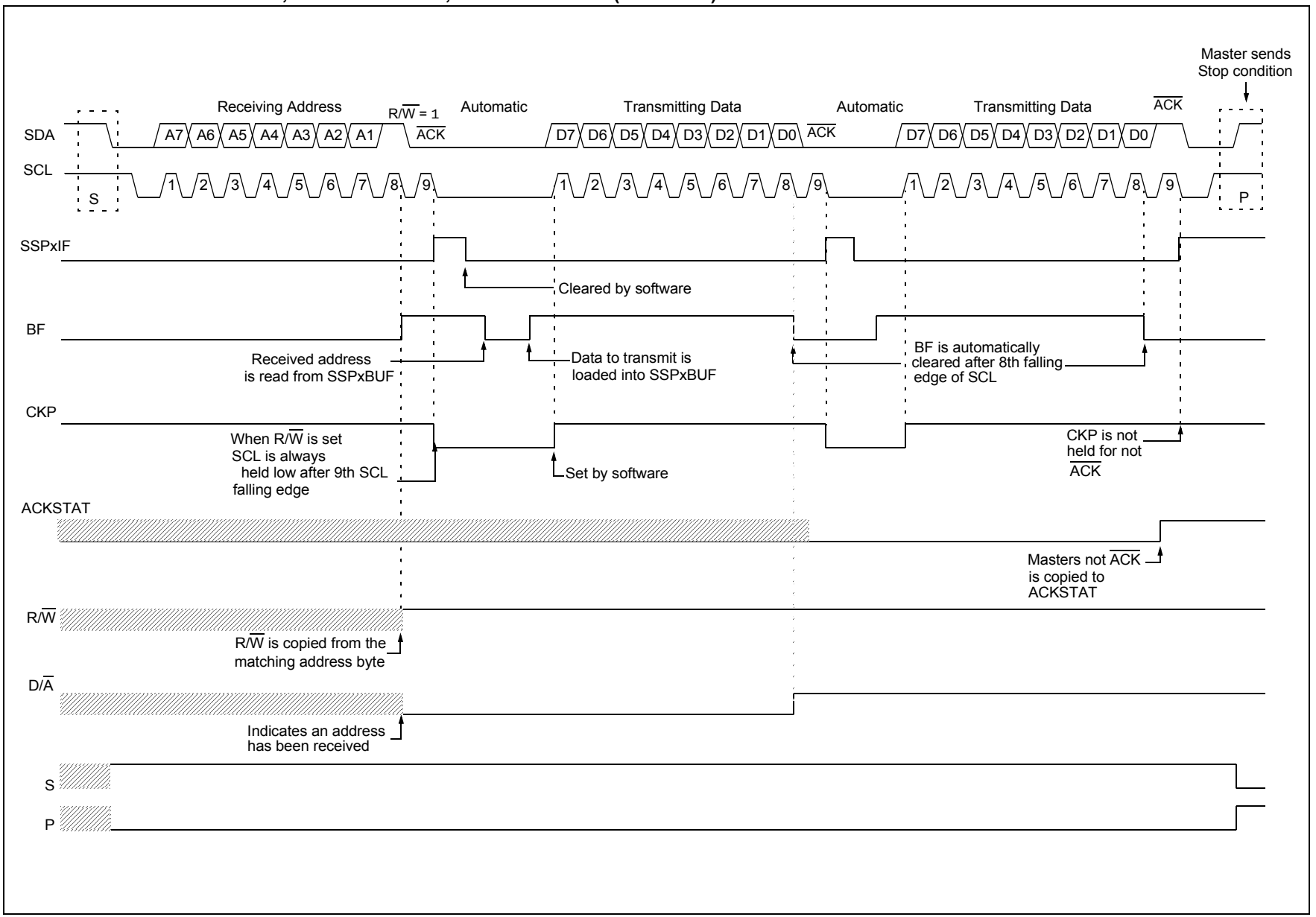
U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
—	—	DBF<5:0>					
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	q = Value depends on condition

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-0 **DBF<5:0>:** Falling Event Dead-Band Value for Counter bits

FIGURE 33-18: I²C SLAVE, 7-BIT ADDRESS, TRANSMISSION (AHEN = 0)



35.5.2 AUTOMATIC POWER MODE SWITCHING

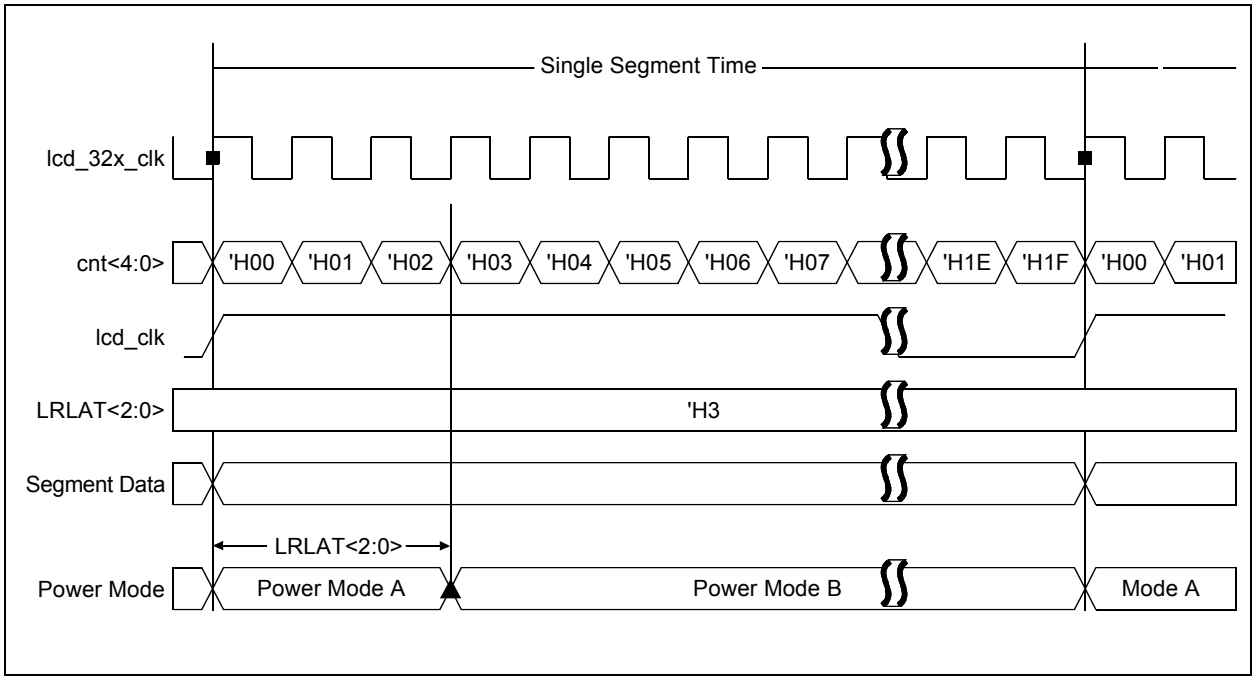
Each segment within an LCD display is perceived electrically like a small capacitor. Due to this fact, power is mainly consumed during the transition periods when voltage is being supplied to the segments. So in order to manage total current consumption, the LCD reference ladder can be used in different power modes during these transition periods. Control of the LCD reference ladder is done through the LCDRL register (see Register 35-7).

The automatic power switching using Type-A/Type-B, can optimize the power consumption for a given contrast.

As shown in Figure 35-3, Power Mode A is active for a programmable time, beginning when the LCD segment waveform is transitioning. The LRLAT<2:0> bits (LCDRL<2:0>) select how long Mode A is active. Power mode B is active for the remaining time before the segments or commons change again.

As shown in Figure 35-3, there are 32 counts in a single segment time. Type-A is used when the wave form is in transition. Type-B can be used when the segment voltage is stable or not in transition.

FIGURE 35-3: LCD REFERENCE LADDER POWER MODE SWITCHING DIAGRAM

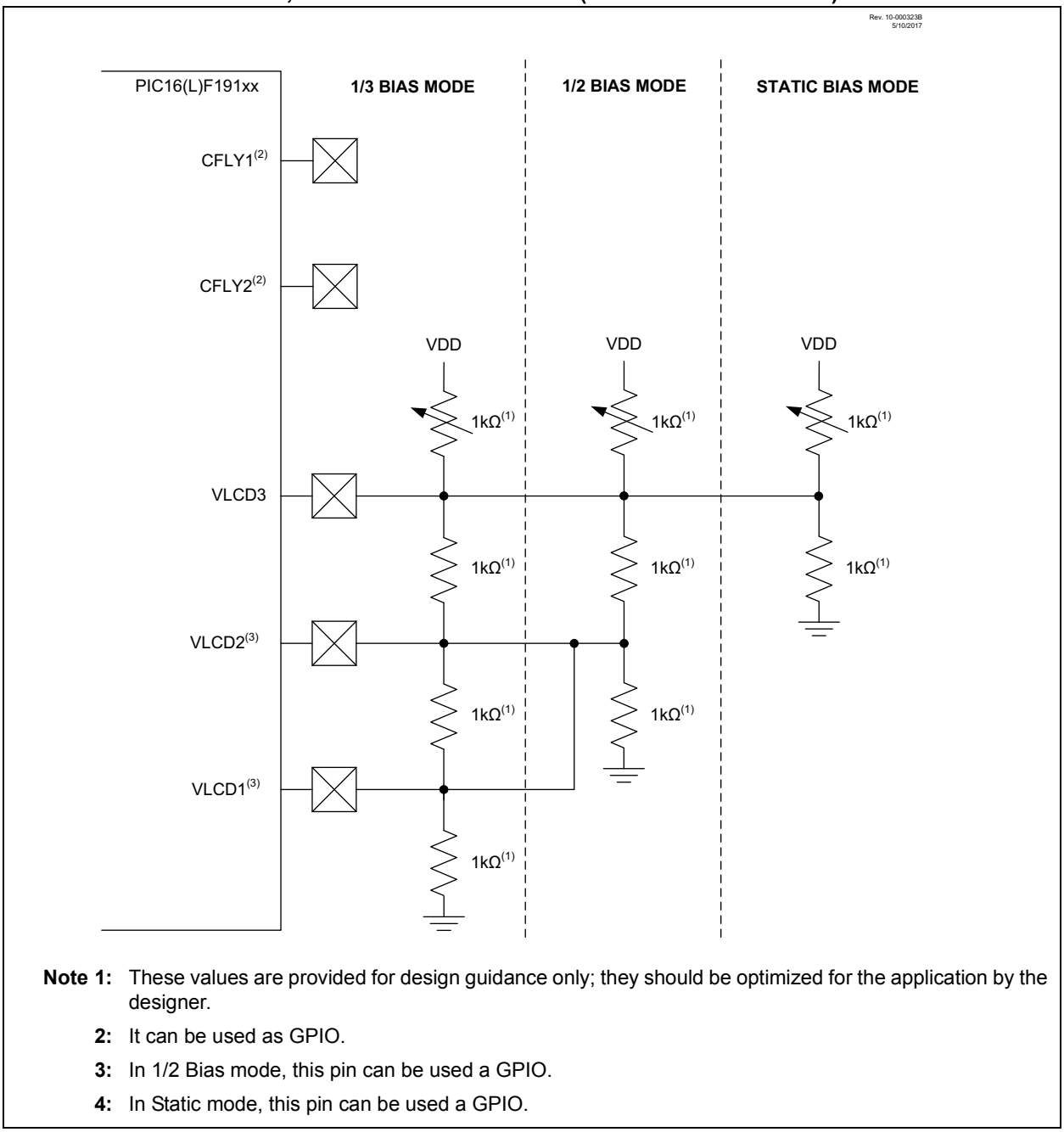


35.7.3 LCD VOLTAGE SUPPLIED FROM EXTERNAL RESISTOR LADDER

In this mode, the LCD charge pump is completely disabled. The LCD bias levels are tied to VDD and are generated using an external divider. The difference is that the internal voltage reference is also disabled and the bottom of the ladder is tied to ground (VSS); see Figure 35-6. The value of the resistors, and the difference between VSS and VDD, determine the contrast range; no software adjustment is possible. This configuration is also used where the LCD's current requirements exceed the capacity of the charge pump and the high power (HP) internal resistor ladder and the software contrast control is not needed.

Depending on the bias type required, resistors are connected between some or all of the pins. A potentiometer can also be connected between VLCD3 and VDD to allow for hardware controlled contrast adjustment.

FIGURE 35-6: CONNECTIONS FOR LCD VOLTAGE SUPPLIED FROM EXTERNAL LADDER, STATIC, 1/2 AND 1/3 BIAS MODES (LCDVSRC<3:0> = 1000)



Note 1: These values are provided for design guidance only; they should be optimized for the application by the designer.

2: It can be used as GPIO.

3: In 1/2 Bias mode, this pin can be used a GPIO.

4: In Static mode, this pin can be used a GPIO.

REGISTER 35-3: LCDSEx: LCD SEGMENT x ENABLE REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SE(n)	SE(n)	SE(n)	SE(n)	SE(n)	SE(n)	SE(n)	SE(n)
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **SE(n+7):SE(n)** Segment Enable bits

For LCDSE0: n = 0-7
For LCDSE1: n = 8-15
For LCDSE2: n = 16-23
For LCDSE3: n = 24-31
For LCDSE4: n = 32-39
For LCDSE5: n = 40-47

1 = Segment function of the pin is enabled, digital I/O is disabled
0 = Segment function of the pin is disabled, digital I/O is enabled

REGISTER 35-4: LCDDATAx: LCD DATA x REGISTER

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
SEGxCOMy	SEGxCOMy	SEGxCOMy	SEGxCOMy	SEGxCOMy	SEGxCOMy	SEGxCOMy	SEGxCOMy
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **SEGxCOMy:** Pixel On bits

1 = Pixel on
0 = Pixel off

TRIS **Load TRIS Register with W**

Syntax:	[*label*] TRIS f
Operands:	$5 \le f \le 7$
Operation:	(W) → TRIS register 'f'
Status Affected:	None
Description:	Move data from W register to TRIS register. When 'f' = 5, TRISA is loaded. When 'f' = 6, TRISB is loaded. When 'f' = 7, TRISC is loaded.

XORLW **Exclusive OR literal with W**

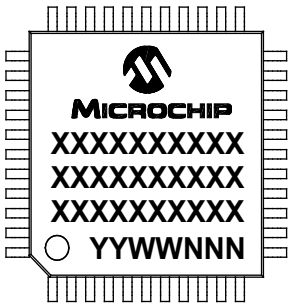
Syntax:	[*label*] XORLW k
Operands:	$0 \le k \le 255$
Operation:	(W) .XOR. k → (W)
Status Affected:	Z
Description:	The contents of the W register are XOR'ed with the 8-bit literal 'k'. The result is placed in the W register.

XORWF **Exclusive OR W with f**

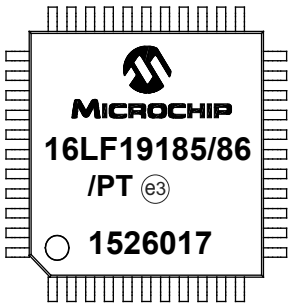
Syntax:	[*label*] XORWF f,d
Operands:	$0 \le f \le 127$ $d \in [0,1]$
Operation:	(W) .XOR. (f) → (destination)
Status Affected:	Z
Description:	Exclusive OR the contents of the W register with register 'f'. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the result is stored back in register 'f'.

42.1 Package Marking Information (Continued)

48-Lead TQFP (7x7x1 mm)



Example

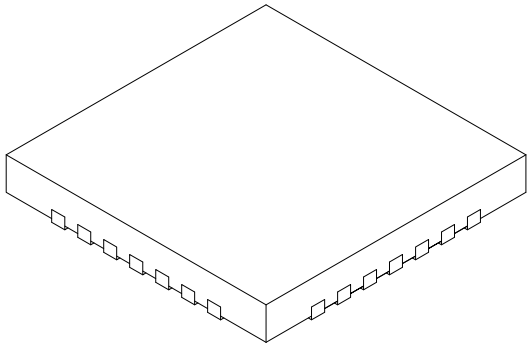


Legend:	XX...X	Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week ‘01’)
	NNN	Alphanumeric traceability code
		Pb-free JEDEC® designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

28-Lead Plastic Ultra Thin Quad Flat, No Lead Package (MV) – 4x4x0.5 mm Body [UQFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		28	
Pitch	e		0.40 BSC	
Overall Height	A	0.45	0.50	0.55
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3		0.127 REF	
Overall Width	E		4.00 BSC	
Exposed Pad Width	E2	2.55	2.65	2.75
Overall Length	D		4.00 BSC	
Exposed Pad Length	D2	2.55	2.65	2.75
Contact Width	b	0.15	0.20	0.25
Contact Length	L	0.30	0.40	0.50
Contact-to-Exposed Pad	K	0.20	-	-

Notes:

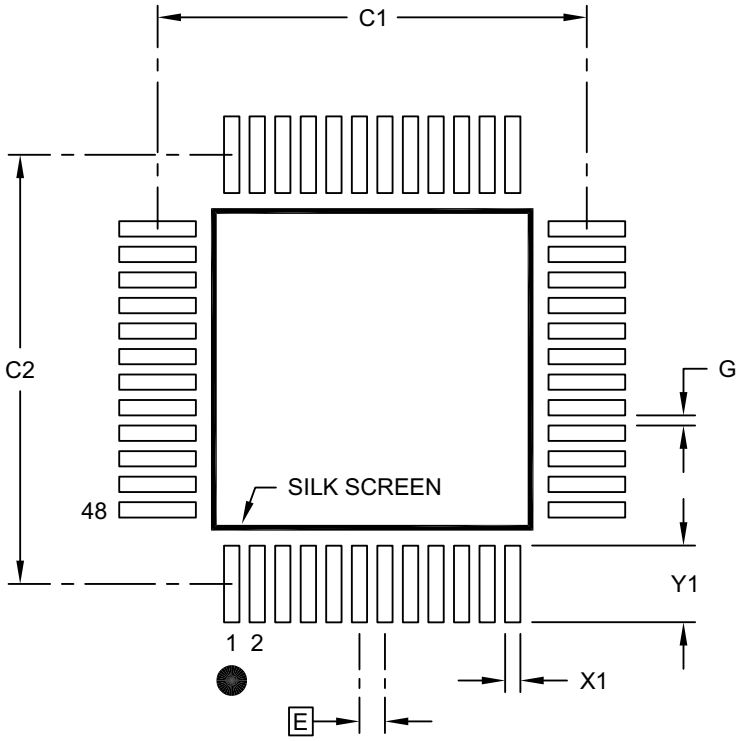
1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated.
3. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-152A Sheet 2 of 2

48-Lead Thin Quad Flatpack (PT) - 7x7x1.0 mm Body [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.50 BSC	
Contact Pad Spacing	C1		8.40	
Contact Pad Spacing	C2		8.40	
Contact Pad Width (X48)	X1			0.30
Contact Pad Length (X48)	Y1			1.50
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M
   BSC: Basic Dimension. Theoretically exact value shown without tolerances.
2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-2300-PT Rev A

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